



DOCKET NO.: 01-C-055  
CLIENT NO.: STMI01-01055  
Customer No.: 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: : Harry Michael Siegel et al.  
Application No. : 10/062,595  
Filed : January 31, 2002  
For : SYSTEM AND METHOD FOR ALIGNING AN INTEGRATED  
CIRCUIT DIE ON AN INTEGRATED CIRCUIT SUBSTRATE  
Group No. : 3725  
Examiner : David B. Jones

MAIL STOP ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

AMENDMENT UNDER 37 C.F.R. § 1.312

Pursuant to 37 C.F.R. § 1.312, please amend the above-identified application as follows:

Please  
Enter  
under

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DBT